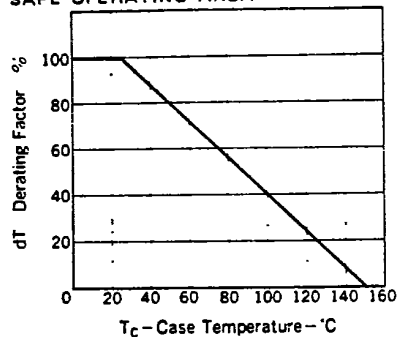
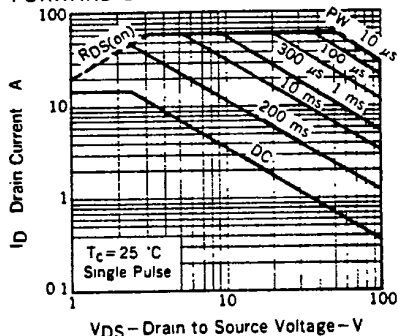
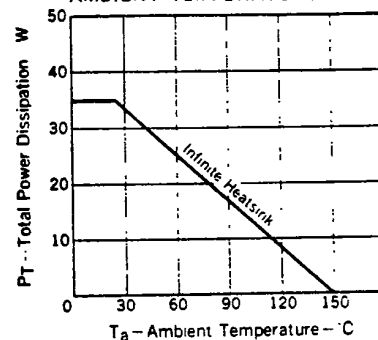
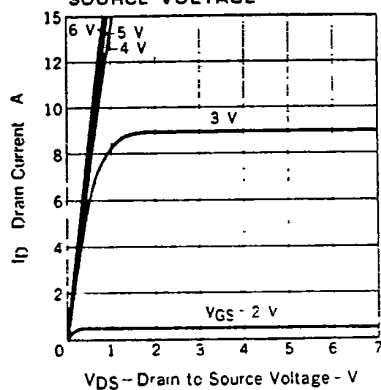
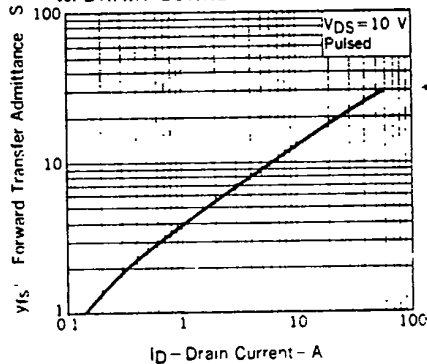
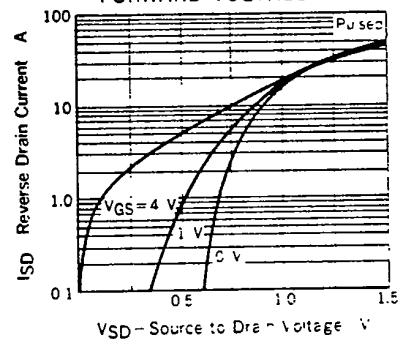
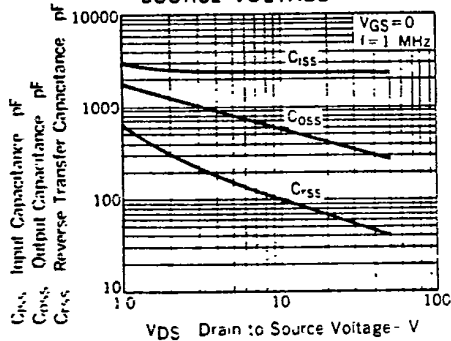
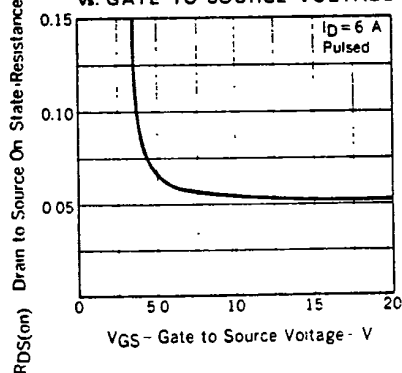
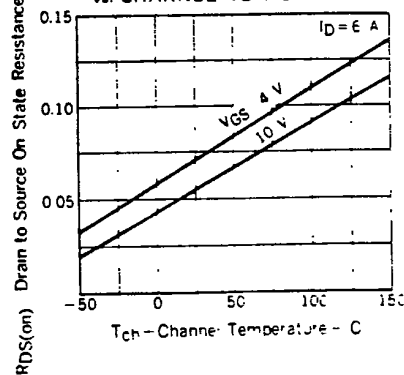
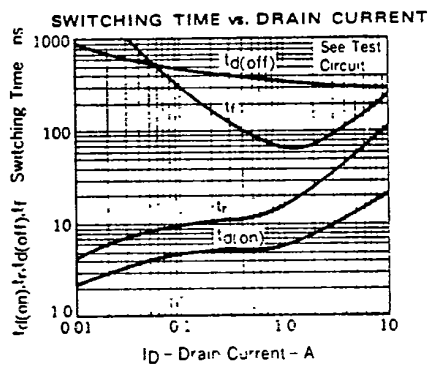
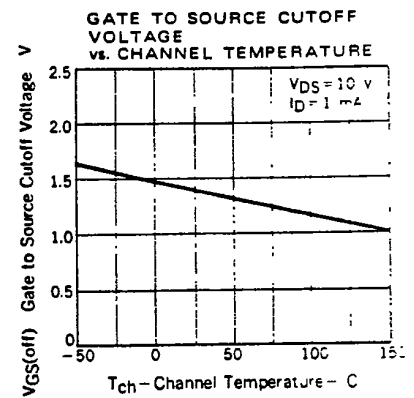
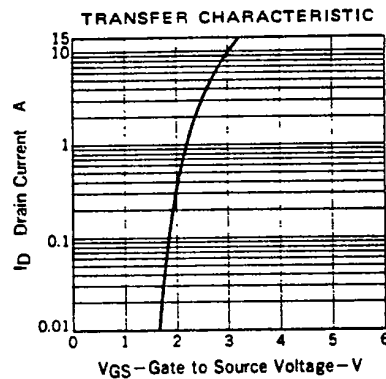
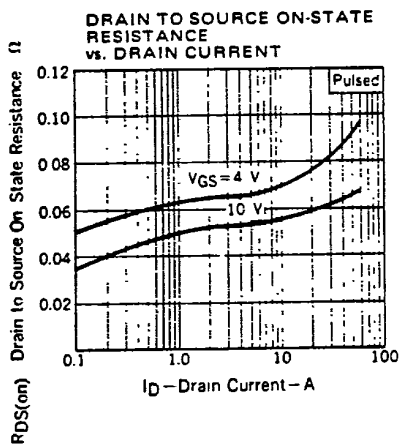


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TYPICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)DERATING FACTOR OF FORWARD BIAS
SAFE OPERATING AREA

FORWARD BIAS SAFE OPERATING AREA

TOTAL POWER DISSIPATION vs.
AMBIENT TEMPERATUREDRAIN CURRENT vs. DRAIN TO
SOURCE VOLTAGEFORWARD TRANSFER ADMITTANCE
vs. DRAIN CURRENTSOURCE TO DRAIN DIODE
FORWARD VOLTAGECAPACITANCE vs. DRAIN TO
SOURCE VOLTAGEDRAIN TO SOURCE ON-STATE
RESISTANCE
vs. GATE TO SOURCE VOLTAGEDRAIN TO SOURCE ON-STATE
RESISTANCE
vs. CHANNEL TEMPERATURE



SWITCHING TIME TEST CIRCUIT

